



AMENDMENT TRANSMITTAL LETTER

Docket No.
M4065.0159/P159-A

Application No.
09/902,691

Filing Date
July 12, 2001

Examiner
P. Brock

Art Unit
2815

Applicant(s): Li Li, et al

Invention: METHOD OF CONTROLLING SRIATIONS AND CD LOSS IN CONTACT OXIDE ETCH

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	27	- 28 =		x	0.00
Independent Claims	2	- 3 =		x	0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					0.00

☒ Large Entity

☐ Small Entity

☒ No additional fee is required for this amendment.

☐ Please charge Deposit Account No. _____ in the amount of \$ _____.
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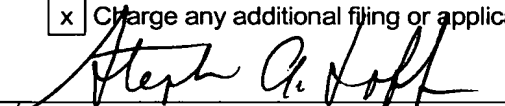
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Stephen A. Soffen
Attorney Reg. No.: 31,063

Dated: January 15, 2003

DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP
2101 L Street NW
Washington, DC 20037-1526
(202) 828-2232

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Amold C
D. Small
S. Logan
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Docket No.: M4065.0159/P159-A
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Li Li, et al.

Application No.: 09/902,691

Group Art Unit: 2815

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Examiner: P. Brock

For: METHOD OF CONTROLLING
SRIATIONS AND CD LOSS IN CONTACT
OXIDE ETCH

AMENDMENT

Box Non-Fee Amendment

Commissioner for Patents
Washington, DC 20231

Dear Sir:

In response to the Office Action dated October 15, 2002 (Paper No. 6), please amend the above-identified U.S. patent application as follows:

In the Claims

Please cancel claims 61, 63, and 65.

Please add new claims 94 and 95 as follows:

94. (New) The integrated circuit substrate of claim 59 wherein the critical dimension loss is reduced by about 400 angstroms.

95. (New) The integrated circuit substrate of claim 92 wherein the critical dimension loss is decreased by about 400 angstroms.

Please amend claims 59 and 92 as shown in the Replacement Claims: